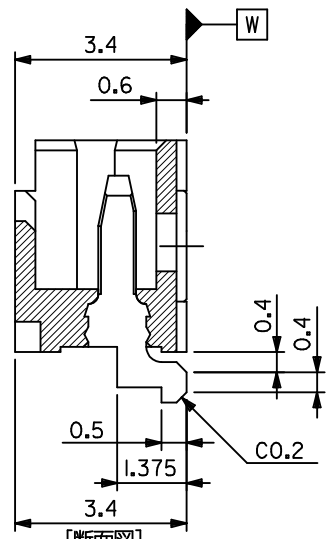
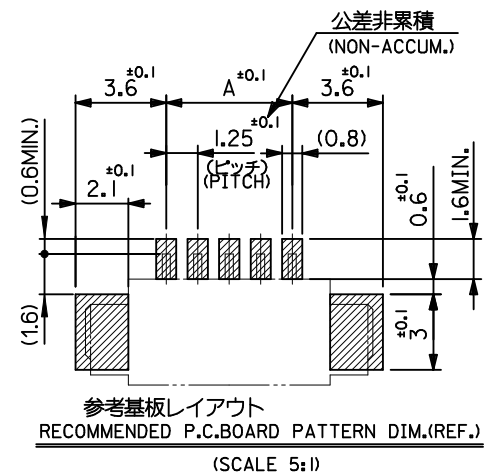
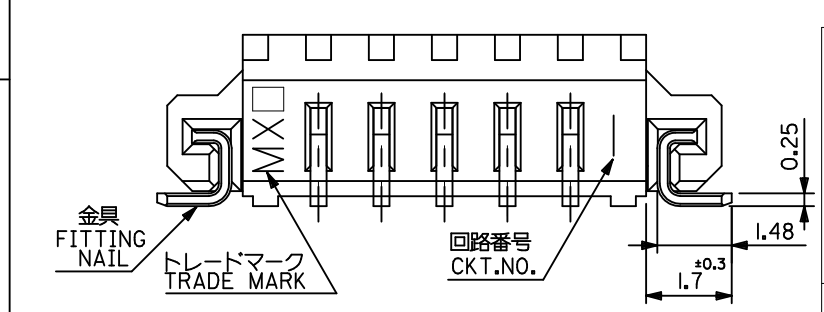
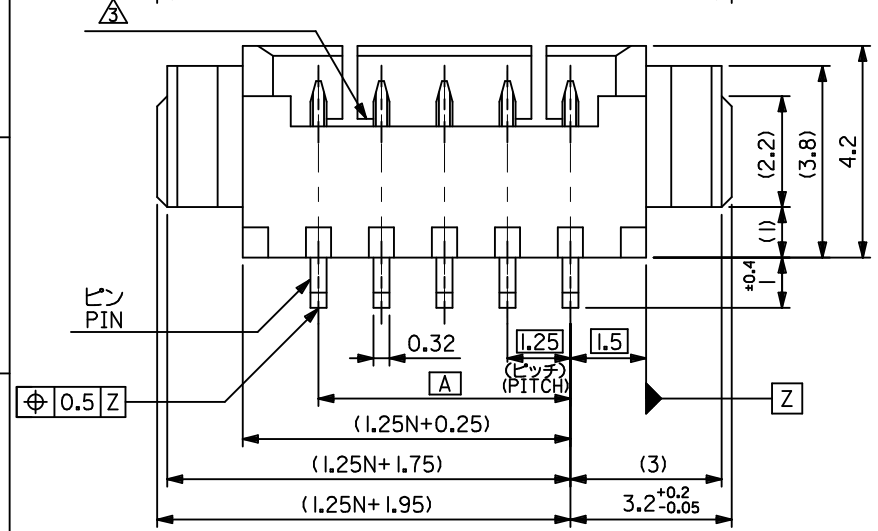
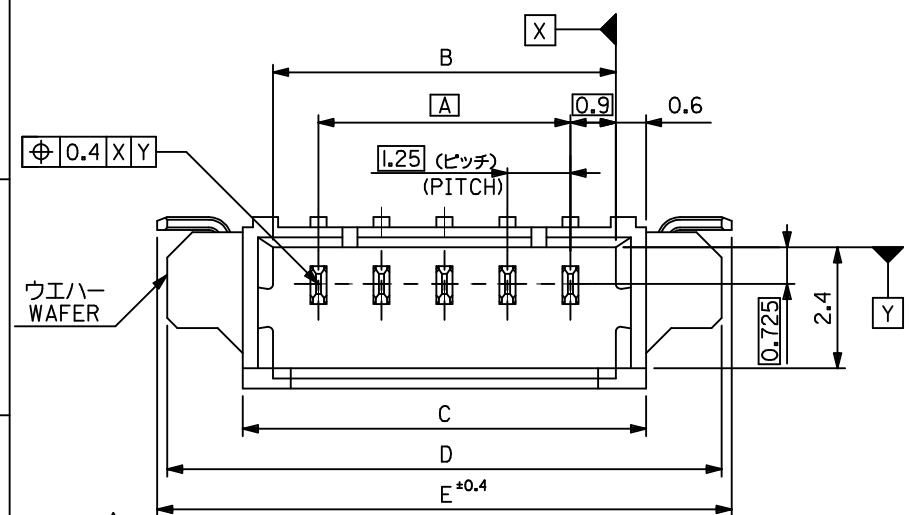




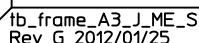
[断面図]

[CROSS SECTION]

- 注記 NOTES
1. 嵌合相手: 51021 シリウス
MATES WITH: 51021 SERIES
 2. 材質 MATERIAL
ウエハー: NYLON46, UL94V-0
ピン: リン青銅, 半田メッキ
PIN: PHOS-BRO., Sn-Pb(9:1) 3 μmMIN.
OVER Cu 1 μmMIN.
PLATING
金具: リン青銅, 半田メッキ
FITTING NAIL: PHOS-BRO., Sn-Pb(9:1) 2 μmMIN.
OVER Cu 1 μmMIN.
PLATING
 3. ロック窓は2、3極は1箇所、4極以上は2箇所とする。
LOCKING WINDOW: ONE PLACE FOR 2 AND 3 CKT. AND TWO PLACES FOR MORE THAN 3 CKT.
 4. ソルダータール部のズレ量及び金具 (補強板) のズレ量は基準面 W に対し、上方向 0.05 MAX.、下方向に 0.1 MAX. とする。
OFFSET BETWEEN BASIS PLANE W TO SOLDER TAIL BOTTOM AND FITTING NAIL BOTTOM: UPPER SIDE: 0.05MAX. LOWER SIDE: 0.1MAX.

23.9	23.5	20.5	19.3	17.5	53261-1510	15
22.65	22.25	19.25	18.05	16.25	-1410	14
21.4	21	18	16.8	15	-1310	13
20.15	19.75	16.75	15.55	13.75	-1210	12
18.9	18.5	15.5	14.3	12.5	-1110	11
17.65	17.25	14.25	13.05	11.25	-1010	10
16.4	16	13	11.8	10	-0910	9
15.15	14.75	11.75	10.55	8.75	-0810	8
13.9	13.5	10.5	9.3	7.5	-0710	7
12.65	12.25	9.25	8.05	6.25	-0610	6
11.4	11	8	6.8	5	-0510	5
10.15	9.75	6.75	5.55	3.75	-0410	4
8.9	8.5	5.5	4.3	2.5	-0310	3
7.65	7.25	4.25	3.05	1.25	53261-0210	2
E	D	C	B	A	ENG. NO.	極数 CKT.

REVISED EC NO: J2012-1315 2012/04/17 DRWN: NITO CHKD: KASAKAWA 2012/04/17 APPR: YOITO 2012/04/26	DESCRIPTION GENERAL TOLERANCES (UNLESS SPECIFIED) 10 UNDER ±0.2 10 OVER 30 UNDER ±0.25 30 OVER ±0.3 ANGULAR ±3 ° DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	DIMENSION STYLE MM ONLY	SCALE 10:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
		DRAWN BY NITO	DATE 2012/04/17	TITLE 1.25 WIRE TO BOARD WAFER ASS FOR SMT RIGHT ANGLE		
		CHECKED BY KASAKAWA	DATE 2012/04/17	MATERIAL NO. SEE DRAWING		
		APPROVED BY YOITO	DATE 2012/04/26	DOCUMENT NO. SD-53261-054		
SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				



10

9

8

7

6

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4

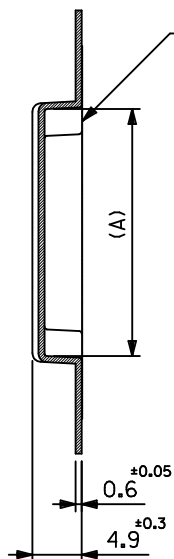
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2

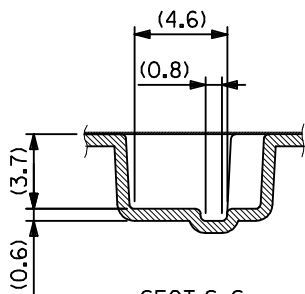
1

引き出し方向
PULL OUT DIRECTION

トップテープ
TOP TAPE



SECT:R-R



SECT:S-S

44mm幅キャリアテープ
44mm WIDTH CARRIER TAPE

REVISED
EC NO: J2014-1616
DRWN: TYAJIMA01
CHKD: KASAKAWA
APPR: NUKITA
G

DESCRIPTION
REV

GENERAL TOLERANCES
(UNLESS SPECIFIED)

10 UNDER	± ---
10 OVER 30 UNDER	± ---
30 OVER	± ---

ANGULAR ± --- °
DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

DIMENSION STYLE
MM ONLY

DRAWN BY	DATE
TYAJIMA01	2014/04/28
CHECKED BY	DATE
KASAKAWA	2014/04/28
APPROVED BY	DATE
NUKITA	2014/04/30

MATERIAL NO.
SEE NOTES

SCALE

DESIGN UNITS
METRIC

THIRD ANGLE
PROJECTION

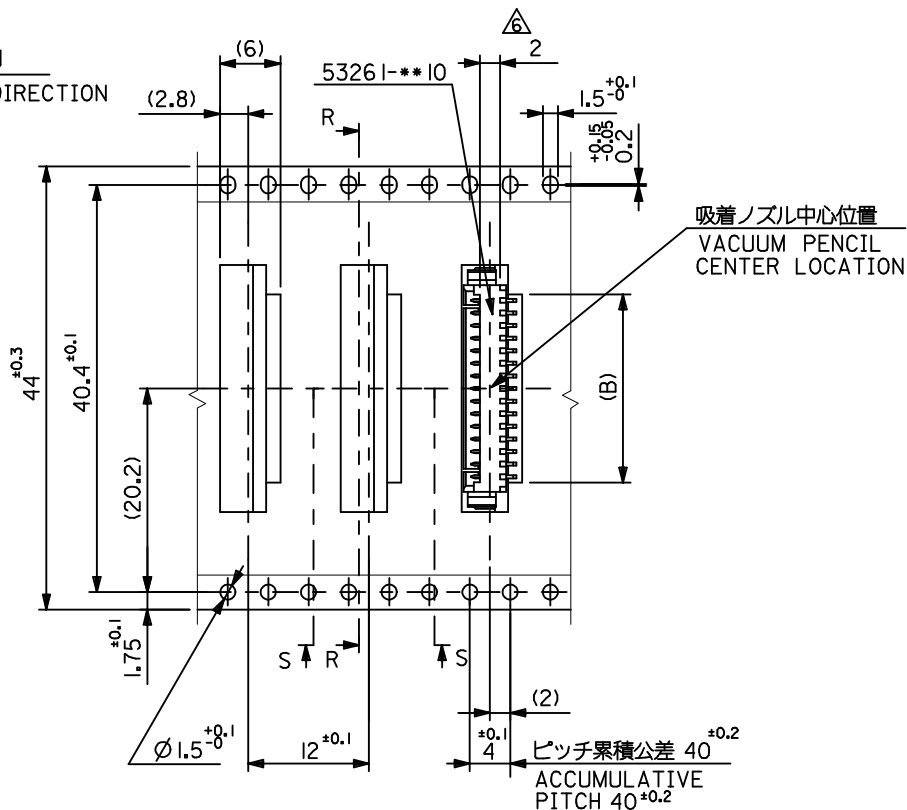
1.25 W/B CONN. WAFER
ASSY FOR SMT. EMBOSSED
TAPE PACKAGE

molex

SD-53261-055

SHEET NO.
3 OF 3

44	44.4	18.7	24.5	53261-I590	I5
		17.45	23.25	53261-I490	I4
キャリアテープ幅 CARRIER TAPE WIDTH	C	B	A	ENG. NO.	極数 CKT.



吸着ノズル中心位置
VACUUM PENCIL
CENTER LOCATION

ピッチ累積公差 40
ACCUMULATIVE
PITCH 40

9

8

7

6

5

4

3

2